

SSM6L11TU

High Speed Switching Applications

- Optimum for high-density mounting in small packages
- Low ON-resistance Q1: $R_{DS(ON)} = 395\text{m}\Omega$ (max) (@ $V_{GS} = 1.8\text{ V}$)
Q2: $R_{DS(ON)} = 430\text{m}\Omega$ (max) (@ $V_{GS} = -2.5\text{ V}$)

Q1 Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

| Characteristics | | Symbol | Rating | Unit |
|----------------------|-------|-----------|----------|------|
| Drain-source voltage | | V_{DS} | 20 | V |
| Gate-source voltage | | V_{GSS} | ± 12 | V |
| Drain current | DC | I_D | 0.5 | A |
| | Pulse | I_{DP} | 1.5 | |

Q2 Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

| Characteristics | | Symbol | Rating | Unit |
|----------------------|-------|-----------|----------|------|
| Drain-source voltage | | V_{DS} | -20 | V |
| Gate-source voltage | | V_{GSS} | ± 12 | V |
| Drain current | DC | I_D | -0.5 | A |
| | Pulse | I_{DP} | -1.5 | |

Absolute Maximum Ratings (Q1,Q2 Common)
($T_a = 25^\circ\text{C}$)

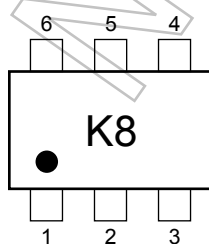
| Characteristics | Symbol | Rating | Unit |
|---------------------------|-------------------|------------|------------------|
| Drain power dissipation | P_D (Note 1) | 500 | mW |
| Channel temperature | T_{ch} | 150 | $^\circ\text{C}$ |
| Storage temperature range | T_{stg} | -55 to 150 | $^\circ\text{C}$ |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

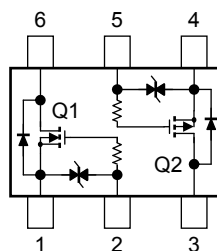
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on FR4 board. (total dissipation)
($25.4\text{ mm} \times 25.4\text{ mm} \times 1.6\text{ t}$, Cu Pad: 645 mm^2)

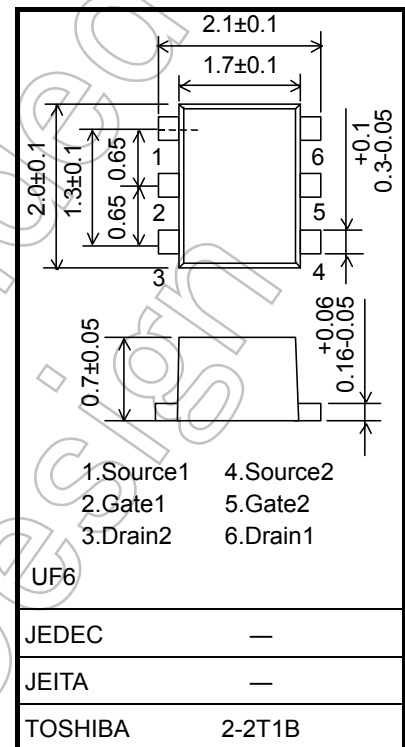
Marking



Equivalent Circuit (top view)



Unit: mm



Weight: 7.0 mg (typ.)

Start of commercial production
2004-03

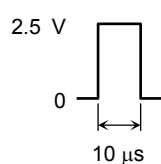
Q1 Electrical Characteristics (Ta = 25°C)

| Characteristics | Symbol | Test Condition | Min | Typ. | Max | Unit |
|--------------------------------|---------------|--|-----|------|---------|-----------|
| Gate leakage current | I_{GSS} | $V_{GS} = \pm 12V, V_{DS} = 0$ | — | — | ± 1 | μA |
| Drain-source breakdown voltage | $V_{(BR)DSS}$ | $I_D = 1\text{ mA}, V_{GS} = 0$ | 20 | — | — | V |
| | $V_{(BR)DSX}$ | $I_D = 1\text{ mA}, V_{GS} = -12\text{ V}$ | 10 | — | — | |
| Drain cut-off current | I_{DSS} | $V_{DS} = 20\text{ V}, V_{GS} = 0$ | — | — | 1 | μA |
| Gate threshold voltage | V_{th} | $V_{DS} = 3\text{ V}, I_D = 0.1\text{ mA}$ | 0.5 | — | 1.1 | V |
| Forward transfer admittance | $ Y_{fs} $ | $V_{DS} = 3\text{ V}, I_D = 0.25\text{ A}$ (Note2) | 1.2 | 2.4 | — | S |
| Drain-source on-resistance | $R_{DS(ON)}$ | $I_D = 0.25\text{ A}, V_{GS} = 4.0\text{ V}$ (Note2) | — | 125 | 145 | $m\Omega$ |
| | | $I_D = 0.25\text{ A}, V_{GS} = 2.5\text{ V}$ (Note2) | — | 150 | 190 | |
| | | $I_D = 0.25\text{ A}, V_{GS} = 1.8\text{ V}$ (Note2) | — | 200 | 395 | |
| Input capacitance | C_{iss} | $V_{DS} = 10\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$ | — | 268 | — | pF |
| Reverse transfer capacitance | C_{rss} | $V_{DS} = 10\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$ | — | 34 | — | pF |
| Output capacitance | C_{oss} | $V_{DS} = 10\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$ | — | 44 | — | pF |
| Switching time | Turn-on time | t_{on} | — | 11 | — | ns |
| | Turn-off time | t_{off} | — | 15 | — | |

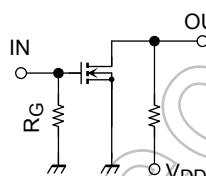
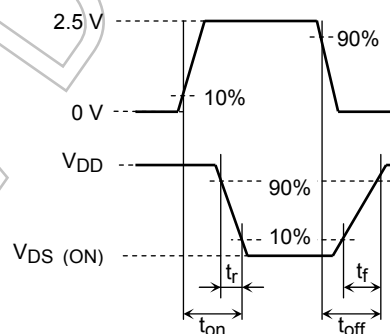
Note2: Pulse test

Switching Time Test Circuit

(a) Test Circuit



$V_{DD} = 10\text{ V}$
 $R_G = 4.7\ \Omega$
Duty $\leq 1\%$
 V_{IN} : $t_r, t_f < 5\text{ ns}$
Common Source
 $T_a = 25^\circ\text{C}$

(b) V_{IN} (c) V_{OUT} 

Precaution

V_{th} can be expressed as the voltage between gate and source when the low operating current value is $I_D = 100\ \mu A$ for this product. For normal switching operation, $V_{GS(ON)}$ requires a higher voltage than V_{th} and $V_{GS(OFF)}$ requires a lower voltage than V_{th} .

(The relationship can be established as follows: $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$)

Please take this into consideration when using the device.

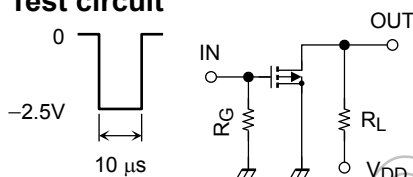
Q2 Electrical Characteristics (Ta = 25°C)

| Characteristics | Symbol | Test Condition | Min | Typ. | Max | Unit |
|--------------------------------|---------------|---|------|------|---------|-----------|
| Gate leakage current | I_{GSS} | $V_{GS} = \pm 12V, V_{DS} = 0$ | — | — | ± 1 | μA |
| Drain-source breakdown voltage | $V_{(BR)DSS}$ | $I_D = -1 mA, V_{GS} = 0$ | -20 | — | — | V |
| | $V_{(BR)DSX}$ | $I_D = -1 mA, V_{GS} = +12 V$ | -8 | — | — | |
| Drain cut-off current | I_{DSS} | $V_{DS} = -20 V, V_{GS} = 0$ | — | — | -1 | μA |
| Gate threshold voltage | V_{th} | $V_{DS} = -3 V, I_D = -0.1 mA$ | -0.5 | — | -1.1 | V |
| Forward transfer admittance | $ Y_{fs} $ | $V_{DS} = -3 V, I_D = -0.25 A$ (Note3) | 0.65 | 1.3 | — | S |
| Drain-source on-resistance | $R_{DS(ON)}$ | $I_D = -0.25 A, V_{GS} = -4 V$ (Note3) | — | 210 | 260 | $m\Omega$ |
| | | $I_D = -0.25 A, V_{GS} = -2.5 V$ (Note3) | — | 310 | 430 | |
| Input capacitance | C_{iss} | $V_{DS} = -10 V, V_{GS} = 0, f = 1 MHz$ | — | 218 | — | pF |
| Reverse transfer capacitance | C_{rss} | $V_{DS} = -10 V, V_{GS} = 0, f = 1 MHz$ | — | 42 | — | pF |
| Output capacitance | C_{oss} | $V_{DS} = -10 V, V_{GS} = 0, f = 1 MHz$ | — | 52 | — | pF |
| Switching time | Turn-on time | $V_{DD} = -10 V, I_D = -0.25 A,$ | — | 16 | — | ns |
| | Turn-off time | $V_{GS} = 0 \text{ to } -2.5 V, R_G = 4.7 \Omega$ | — | 15 | — | |

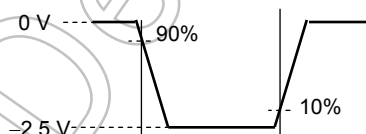
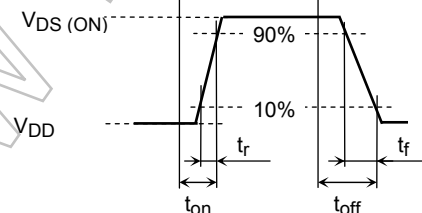
Note3: Pulse test

Switching Time Test Circuit

(a) Test circuit



$V_{DD} = -10 V$
 $R_G = 4.7 \Omega$
Duty $\leq 1\%$
 V_{IN} : $t_r, t_f < 5 ns$
Common Source
 $T_a = 25^\circ C$

(b) V_{IN} (c) V_{OUT} 

Precaution

V_{th} can be expressed as the voltage between gate and source when the low operating current value is $I_D = -100 \mu A$ for this product. For normal switching operation, $V_{GS(on)}$ requires a higher voltage than V_{th} and $V_{GS(off)}$ requires a lower voltage than V_{th} .

(The relationship can be established as follows: $V_{GS(off)} < V_{th} < V_{GS(on)}$)

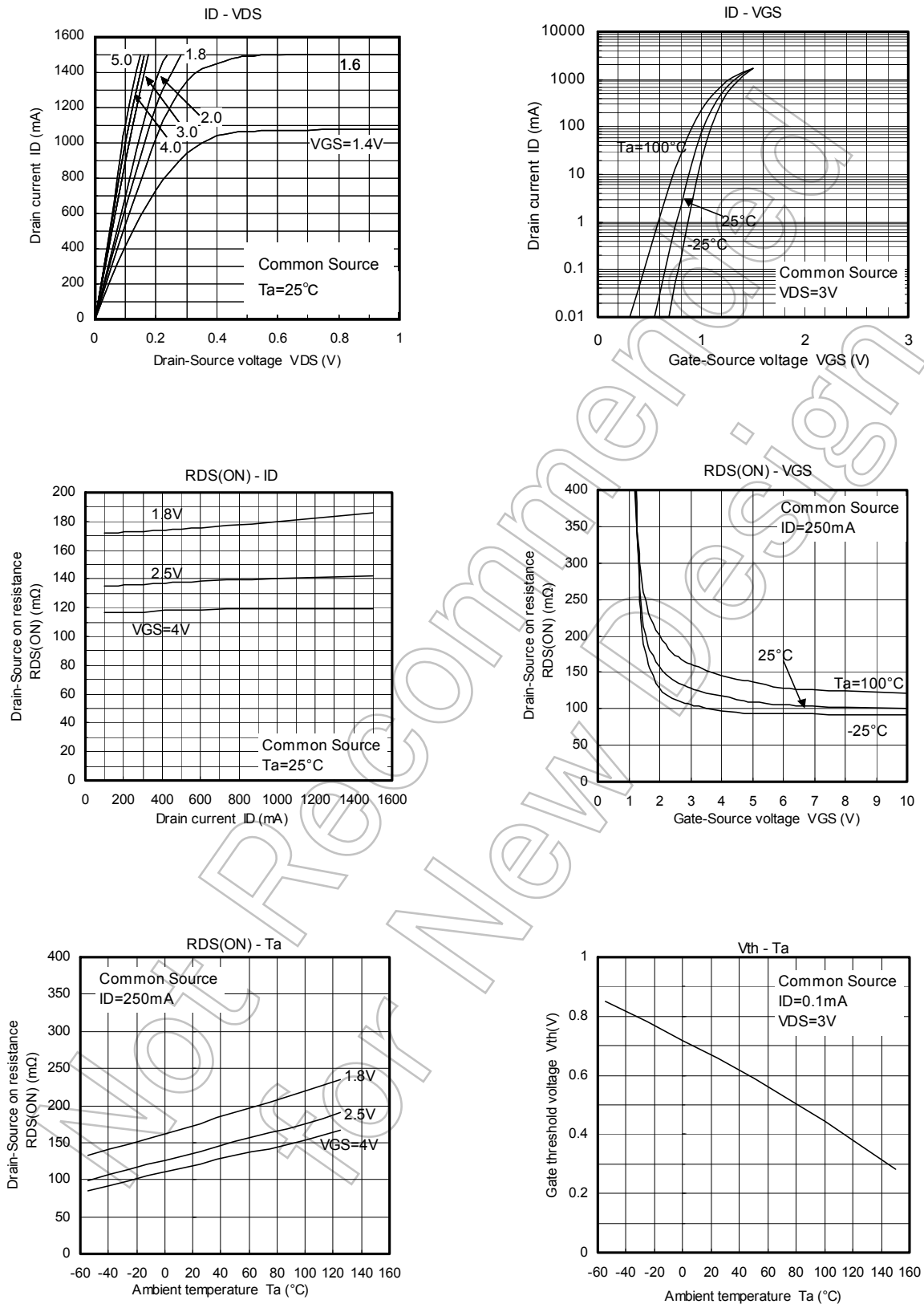
Please take this into consideration when using the device.

Handling Precaution

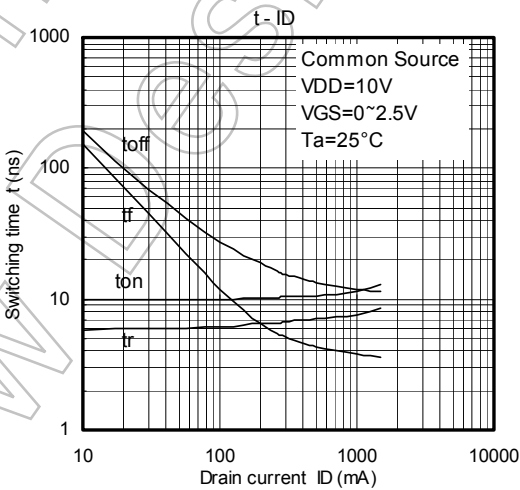
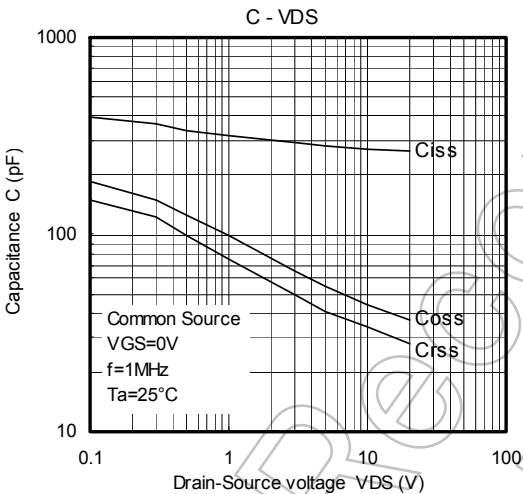
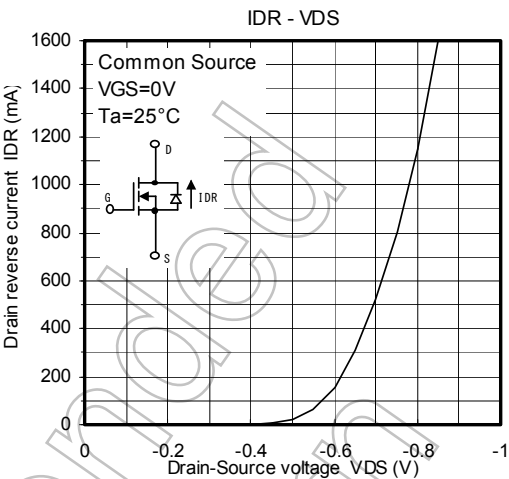
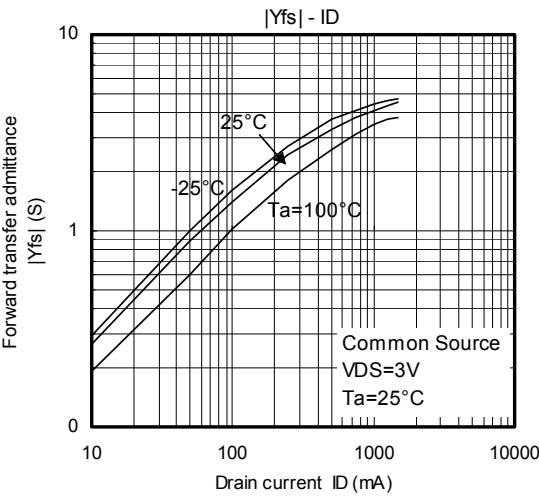
When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Thermal resistance $R_{th(j-a)}$ and drain power dissipation P_D vary depending on board material, board area, board thickness and pad area. When using this device, please take heat dissipation into consideration.

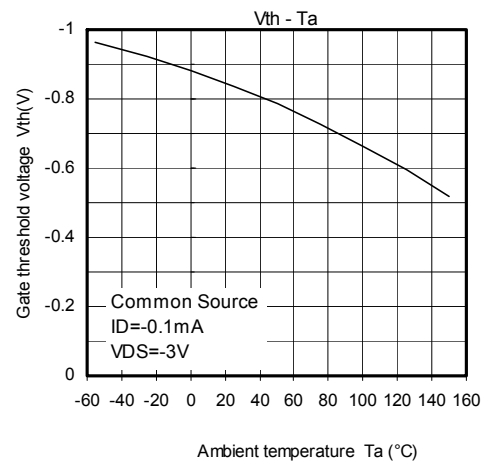
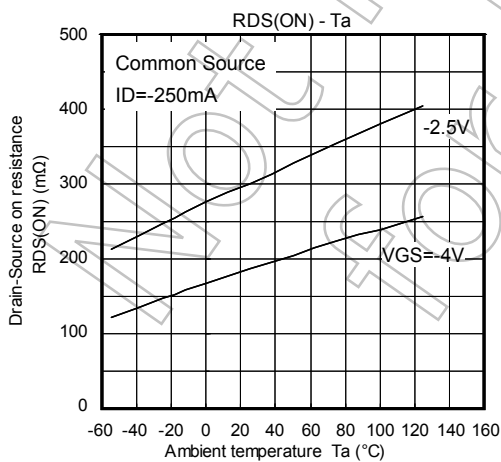
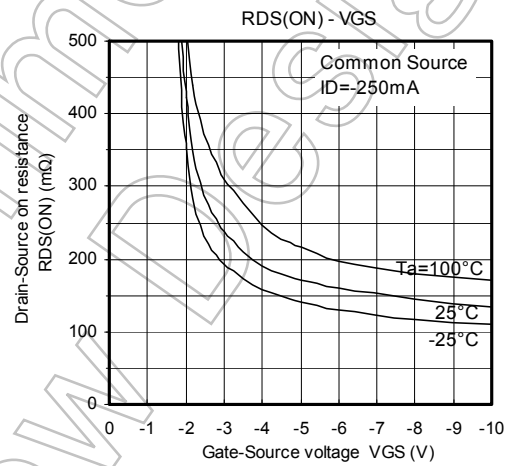
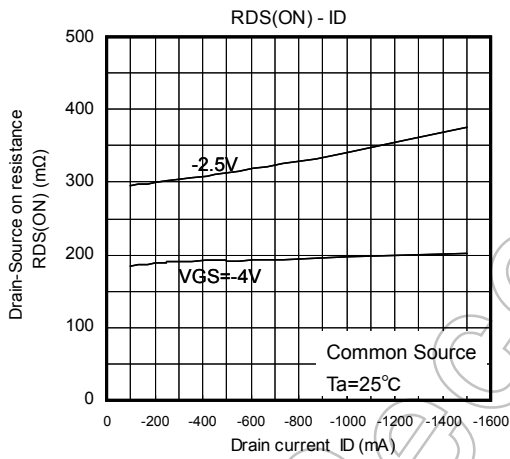
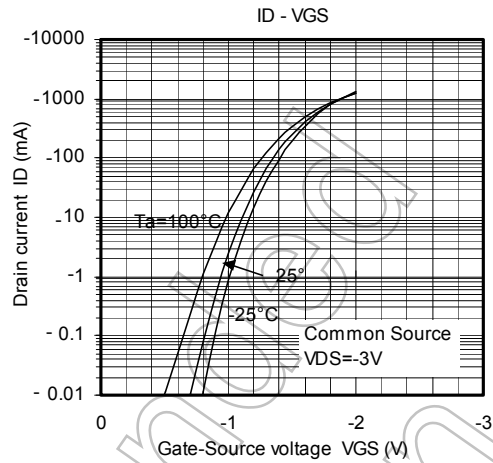
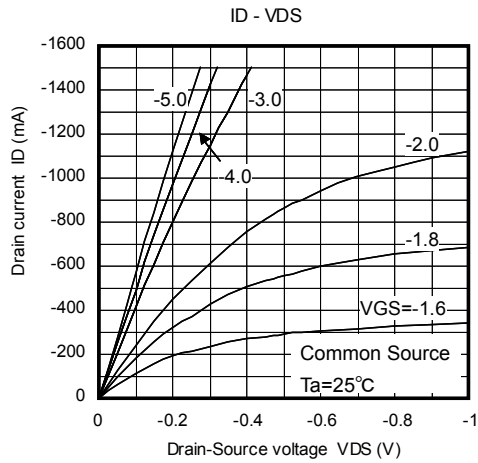
Q1(Nch MOS FET)



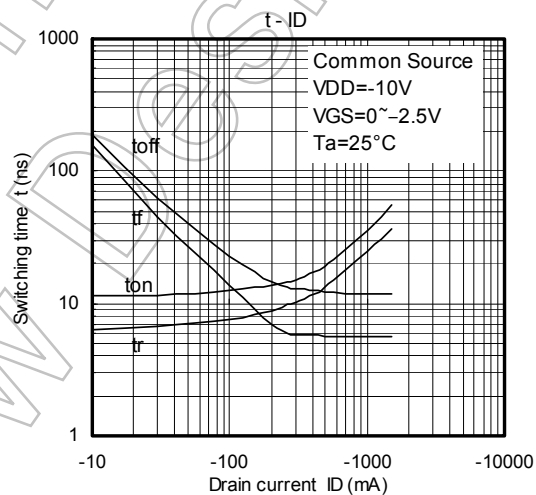
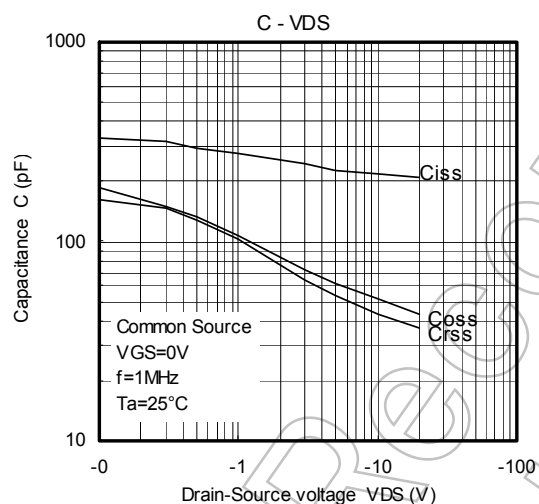
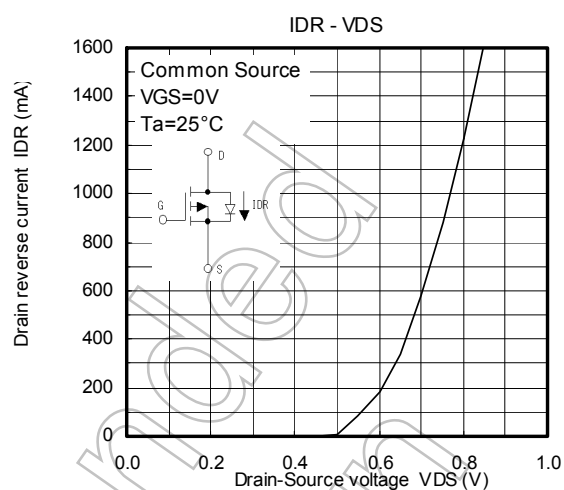
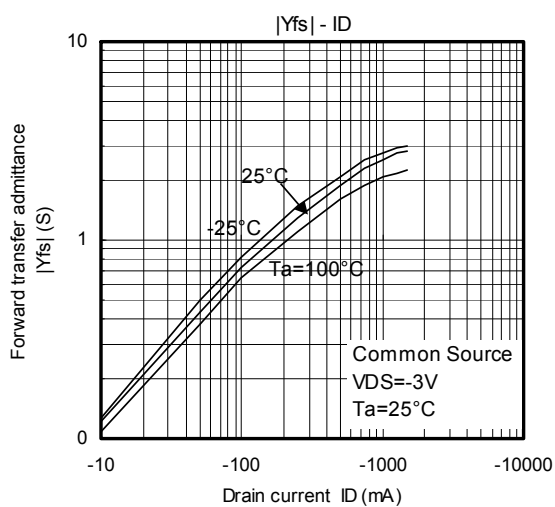
Q1(Nch MOS FET)

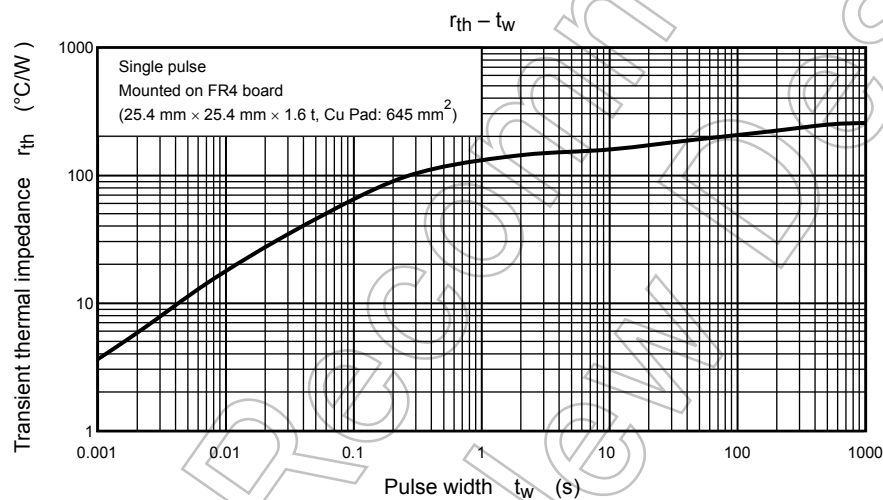
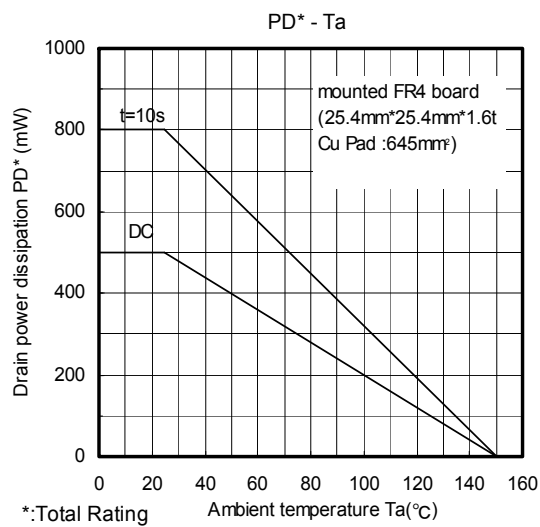


Q2(Pch MOS FET)



Q2(Pch MOS FET)





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